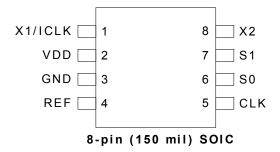
Pin Assignment



Clock Decoding Table (MHz) with 14.31818 **MHz Crystal or Clock Input**

| S1 | S0 | CLK | Multiplier | Accuracy |
|----|----|----------------|------------|----------|
| 0 | 0 | Power-down CLK | _ | _ |
| 0 | 1 | 25 | 1.746 | 1 ppm |
| М | 0 | 33.33 | 2.328 | 0.008% |
| М | 1 | 40 | 2.794 | 1 ppm |
| 1 | 0 | 50 | 3.492 | 1 ppm |
| 1 | 1 | 66.66 | 4.656 | 0.008% |

0 = connect directly to ground

1 = connect directly to VDD

M = leave unconnected (floating)

CLK and REF stop low in power-down state

Pin Descriptions

| Pin Number | Pin Name | Pin Type | Pin Description |
|---------------|-------------|-----------------|--|
| 1 | XI/ICLK | Input | Crystal connection to a 14.31818 MHz crystal or clock input. |
| 2 | VDD | Power | Connect to +3.3 V or +5 V. |
| 3 | GND | Power | Connect to ground. |
| 4 | REF | Output | Reference 14.31818 MHz crystal oscillator buffered clock output. |
| 5 | CLK | Output | Clock output per table above. |
| 6 | S0 | Tri-level Input | Select 0 for output clock. Connect to GND or VDD or float. See table above. |
| 7 | S1 | Tri-level Input | Select 1 for output clock. Connect to GND or VDD or float. See table above. |
| 8 | X2 | Output | Crystal connection to a 14.31818 MHz crystal. Leave unconnected for clock input. |

Notes:

- 1. With S1 = S0 = 0, the internal PLL is turned off and the CLK outputs stops low. The crystal oscillator and REF output are still active.
- 2. With a clock input, the phase relationship between the input and the output clocks can change each time the device is powered on. If a fixed phase relationship is required, use the ICS571 or other zero delay multipliers.

External Components

Decoupling Capacitor

As with any high-performance mixed-signal IC, the ICS514 must be isolated from system power supply noise to perform optimally.

A decoupling capacitor of 0.01µF must be connected between VDD and the GND. It must be connected close to the ICS514 to minimize lead inductance. No external power supply filtering is required for the ICS514.

Series Termination Resistor

A 33Ω terminating resistor can be used next to the CLK and REF pins for trace lengths over one inch.

Crystal Load Capacitors

The total on-chip capacitance is approximately 12 pF. A parallel resonant, fundamental mode crystal should be used. The device crystal connections should include pads for small capacitors from X1 to ground and from

X2 to ground. These capacitors are used to adjust the stray capacitance of the board to match the nominally required crystal load capacitance. Because load capacitance can only be increased in this trimming process, it is important to keep stray capacitance to a minimum by using very short PCB traces (and no vias) between the crystal and device. Crystal capacitors, if needed, must be connected from each of the pins X1 and X2 to ground.

The value (in pF) of these crystal caps should equal (C_L -12 pF)*2. In this equation, C_L = crystal load capacitance in pF. Example: For a crystal with a 16 pF load capacitance, each crystal capacitor would be 8 pF [(16-12) x 2 = 8].

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the ICS514. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| Item | Rating |
|--|---------------------|
| Supply Voltage, VDD | 7 V |
| All Inputs and Outputs (referenced to GND) | -0.5 V to VDD+0.5 V |
| Ambient Operating Temperature | 0 to +70° C |
| Storage Temperature | -65 to +150° C |
| Soldering Temperature | 260° C |

Recommended Operation Conditions

| Parameter | Min. | Тур. | Max. | Units |
|---|------|------|------|-------|
| Ambient Operating Temperature | 0 | | +70 | °C |
| Power Supply Voltage (measured in respect to GND) | +3.0 | | +5.5 | V |

DC Electrical Characteristics

VDD=5.0 V ±5%, Ambient temperature 0 to +70°C, unless stated otherwise

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Units |
|---|-----------------|--------------------------|-----------|-------------|-----------|-------|
| Operating Voltage | VDD | | 3.0 | | 5.5 | ٧ |
| Input High Voltage, ICLK only | V _{IH} | ICLK (pin 1) | (VDD/2)+1 | VDD/2 | | V |
| Input Low Voltage, ICLK only | V _{IL} | ICLK (pin 1) | | VDD/2 | (VDD/2)-1 | V |
| Input High Voltage | V _{IH} | S0 | 2.0 | | | ٧ |
| Input Low Voltage | V _{IL} | S0 | | | 0.8 | V |
| Input High Voltage | V _{IH} | S1 | VDD-0.5 | | | ٧ |
| Input Mid Voltage | V _{IM} | S1 | | VDD/2 | | V |
| Input Low Voltage | V _{IL} | S1 | | | 0.5 | ٧ |
| Output High Voltage | V _{OH} | I _{OH} = -25 mA | 2.4 | | | V |
| Output Low Voltage | V _{OL} | I _{OL} = 25 mA | | | 0.4 | V |
| IDD Operating Supply Current | | No load, 66.66 MHz | | 20 | | mA |
| IDD Power-down Supply Current, 3.3 V | | S1=S0=0 | | 1.5 | | mA |
| Short Circuit Current | | CLK output | | <u>+</u> 70 | | mA |
| On-Chip Pull-up Resistor | | Pin 6 | | 270 | | kΩ |
| Input Capacitance, S1, S0 | | Pins 6, 7 | | 4 | | pF |

AC Electrical Characteristics

VDD = 5.0 V ±5%, Ambient Temperature 0 to +70° C, unless stated otherwise

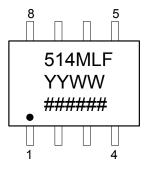
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Units |
|--------------------------------------|------------------|---------------------|------|----------|------|-------|
| Input Frequency, crystal input | F _{IN} | | 5 | 14.31818 | 27 | MHz |
| Input Frequency, clock input | F _{IN} | | 2 | 14.31818 | 50 | MHz |
| Output Frequency, VDD = 4.5 to 5.5 V | F _{OUT} | | 14 | 66.66 | 140 | MHz |
| Output Frequency, VDD = 3.0 to 3.6 V | F _{OUT} | | 14 | 66.66 | 100 | MHz |
| Output Clock Rise Time | t _{OR} | 0.8 to 2.0 V | | 1 | | ns |
| Output Clock Fall Time | t _{OF} | 2.0 to 8.0 V | | 1 | | ns |
| Output Clock Duty Cycle | t _{OD} | 1.5 V,up to 140 MHz | 45 | 49-51 | 55 | % |

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Units |
|---|-----------------|---------------------|------|--------------|------|-------|
| Power-up time, from PD to outputs stable | | | | 5 | 10 | ms |
| Power-down time, from running to PD state | | | | | 50 | ns |
| Absolute Clock Period Jitter | t _{ja} | Deviation from mean | | <u>+</u> 160 | | ps |
| One Sigma Clock Period Jitter | t _{js} | | | 50 | | ps |

Thermal Characteristics

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Units |
|-------------------------------------|---------------|----------------|------|------|------|-------|
| Thermal Resistance Junction to | θ_{JA} | Still air | | 150 | | ° C/W |
| Ambient | θ_{JA} | 1 m/s air flow | | 140 | | ° C/W |
| | θ_{JA} | 3 m/s air flow | | 120 | | ° C/W |
| Thermal Resistance Junction to Case | θ_{JC} | | | 40 | | ° C/W |

Marking Diagram

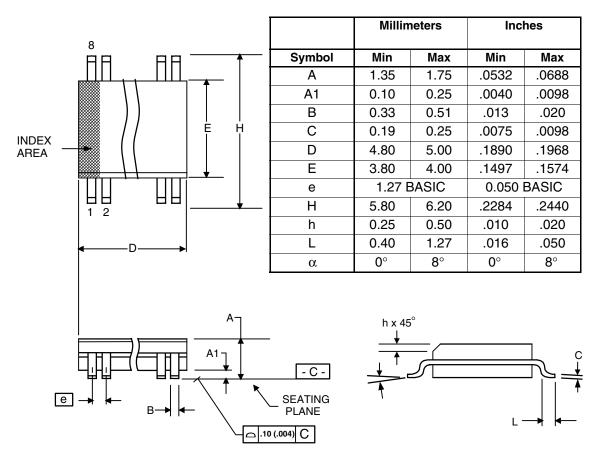


Notes:

- 1. ##### is the lot code.
- 2. YYWW is the last two digits of the year and the week.
- 3. "LF" designates Pb (lead) fee package.

Package Outline and Package Dimensions (8-pin SOIC, 150 Mil. Narrow Body)

Package dimensions are kept current with JEDEC Publication No. 95



Ordering Information

| Part / Order Number | Marking | Shipping Packaging | Package | Temperature |
|---------------------|---------|--------------------|------------|-------------|
| 514MLF | 514MLF | Tubes | 8-pin SOIC | 0 to +70° C |
| 514MLFT | 514MLF | Tape and Reel | 8-pin SOIC | 0 to +70° C |

[&]quot;LF" denotes Pb (lead) free package.

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CLOCK MULTIPLIER

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